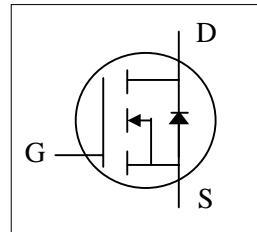
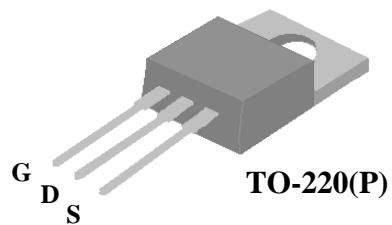


**AP80T12GP-HF****Halogen-Free Product****Advanced Power  
Electronics Corp.****N-CHANNEL ENHANCEMENT MODE  
POWER MOSFET**

- ▼ Simple Drive Requirement
- ▼ Lower On-resistance
- ▼ Fast Switching Characteristic
- ▼ RoHS Compliant & Halogen-Free



$BV_{DSS}$	120V
$R_{DS(ON)}$	9.2mΩ
$I_D$	88A



## Description

AP80T12 series are from Advanced Power innovative design and silicon process technology to achieve the lowest possible on-resistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.

The TO-220 package is widely preferred for all commercial-industrial through hole applications. The low thermal resistance and low package cost contribute to the worldwide popular package.

## Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	120	V
$V_{GS}$	Gate-Source Voltage	+20	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	88	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V$	56	A
$I_{DM}$	Pulsed Drain Current <sup>1</sup>	300	A
$P_D @ T_C = 25^\circ C$	Total Power Dissipation	166	W
$P_D @ T_A = 25^\circ C$	Total Power Dissipation	2	W
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
$T_J$	Operating Junction Temperature Range	-55 to 150	°C

## Thermal Data

Symbol	Parameter	Value	Units
$R_{thj-c}$	Maximum Thermal Resistance, Junction-case	0.75	°C/W
$R_{thj-a}$	Maximum Thermal Resistance, Junction-ambient	62	°C/W



### Electrical Characteristics@ $T_j=25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	120	-	-	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance <sup>2</sup>	$V_{GS}=10V, I_D=40A$	-	-	9.2	$m\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2	-	4	V
$g_f$	Forward Transconductance	$V_{DS}=10V, I_D=40A$	-	100	-	S
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=96V, V_{GS}=0V$	-	-	25	$\mu A$
$I_{GSS}$	Gate-Source Leakage	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	$\pm 100$	$nA$
$Q_g$	Total Gate Charge	$I_D=40A$	-	130	208	$nC$
$Q_{gs}$	Gate-Source Charge	$V_{DS}=96V$	-	20	-	$nC$
$Q_{gd}$	Gate-Drain ("Miller") Charge	$V_{GS}=10V$	-	55	-	$nC$
$t_{d(on)}$	Turn-on Delay Time	$V_{DS}=60V$	-	24	-	ns
$t_r$	Rise Time	$I_D=40A$	-	83	-	ns
$t_{d(off)}$	Turn-off Delay Time	$R_G=3.3\Omega$	-	80	-	ns
$t_f$	Fall Time	$V_{GS}=10V$	-	110	-	ns
$C_{iss}$	Input Capacitance	$V_{GS}=0V$	-	6750	10800	$pF$
$C_{oss}$	Output Capacitance	$V_{DS}=25V$	-	555	-	$pF$
$C_{rss}$	Reverse Transfer Capacitance	$f=1.0MHz$	-	315	-	$pF$
$R_g$	Gate Resistance	$f=1.0MHz$	-	1.8	3.6	$\Omega$

### Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{SD}$	Forward On Voltage <sup>2</sup>	$I_S=40A, V_{GS}=0V$	-	-	1.3	V
$t_{rr}$	Reverse Recovery Time	$I_S=10A, V_{GS}=0V$	-	70	-	ns
$Q_{rr}$	Reverse Recovery Charge	$dI/dt=100A/\mu s$	-	190	-	$nC$

### Notes:

1. Pulse width limited by Max. junction temperature.

2. Pulse test

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

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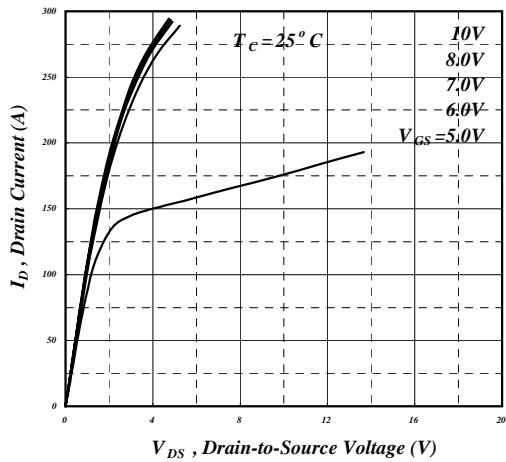


Fig 1. Typical Output Characteristics

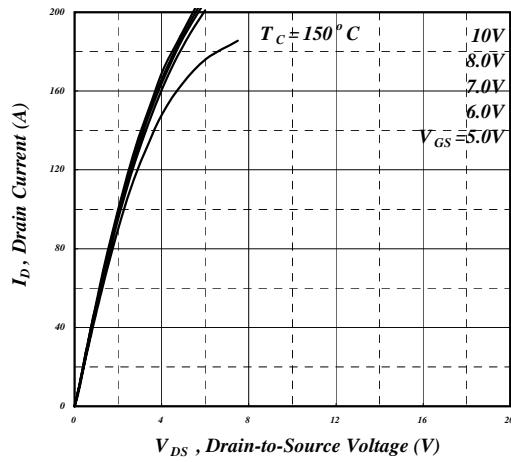


Fig 2. Typical Output Characteristics

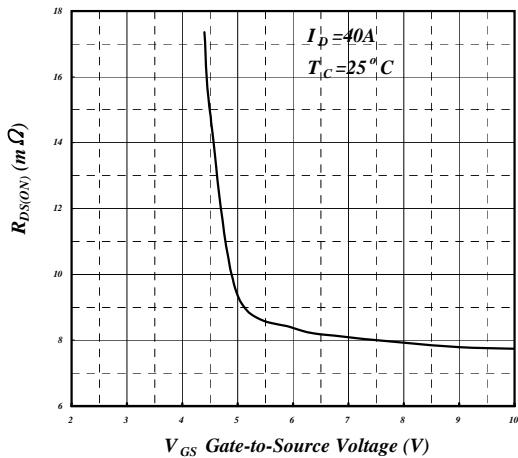


Fig 3. On-Resistance v.s. Gate Voltage

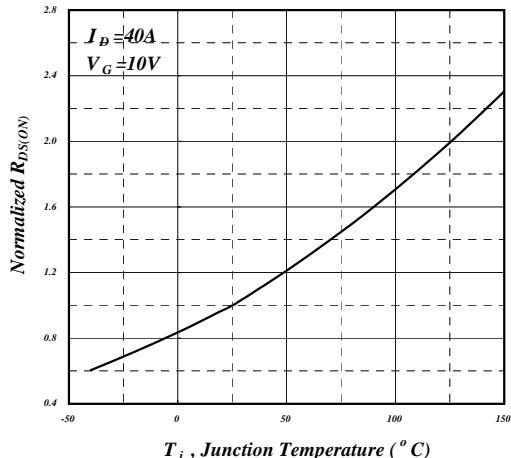


Fig 4. Normalized On-Resistance v.s. Junction Temperature

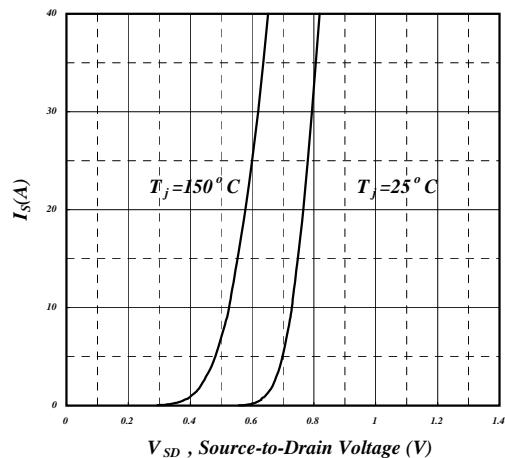


Fig 5. Forward Characteristic of Reverse Diode

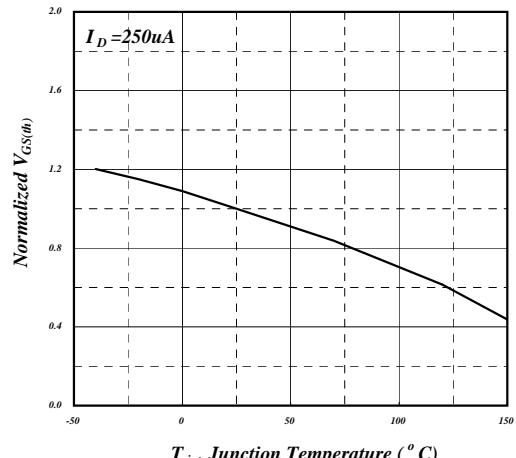


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

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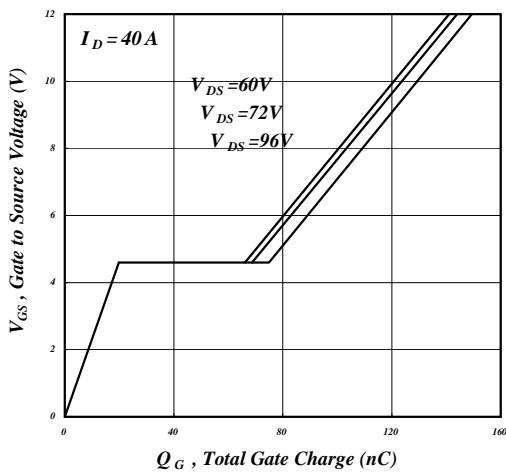


Fig 7. Gate Charge Characteristics

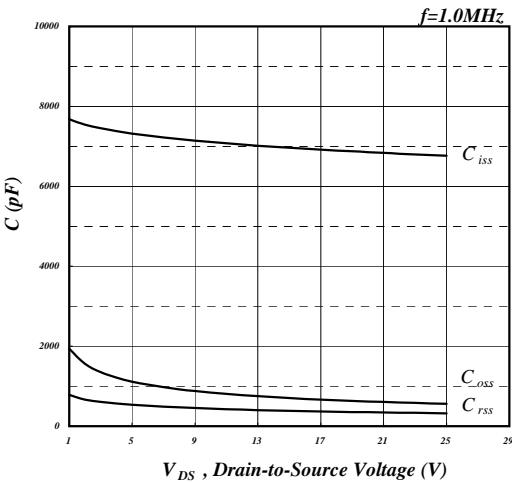


Fig 8. Typical Capacitance Characteristics

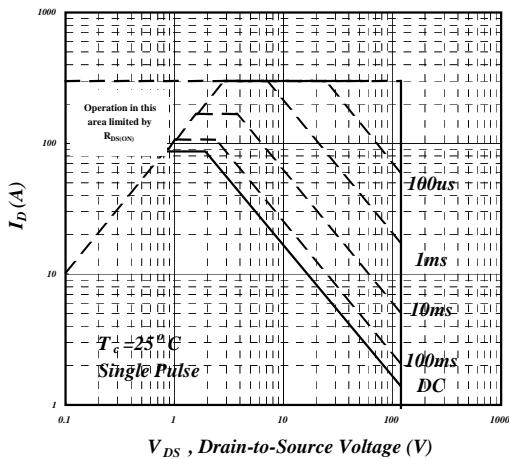


Fig 9. Maximum Safe Operating Area

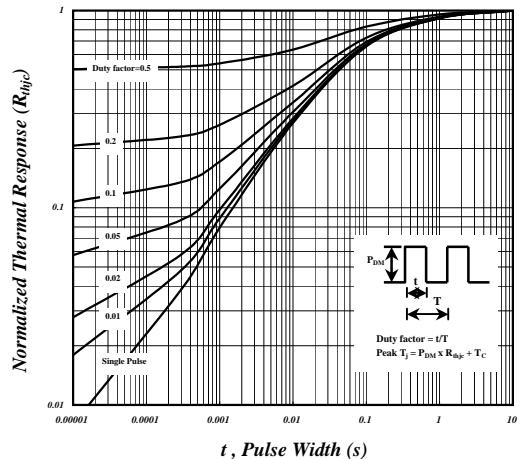


Fig 10. Effective Transient Thermal Impedance

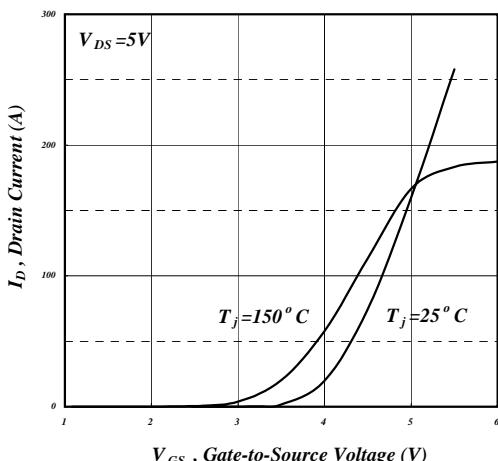


Fig 11. Transfer Characteristics

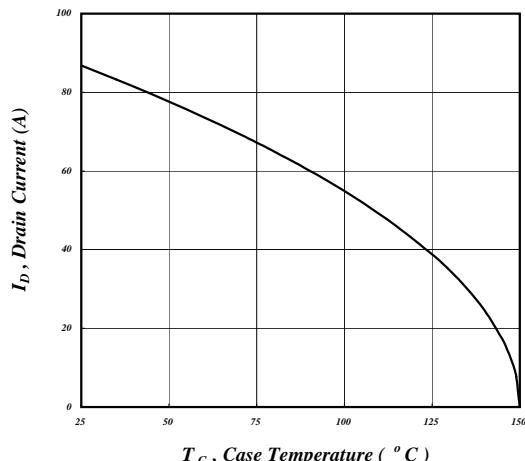


Fig 12. Maximum Continuous Drain Current v.s. Case Temperature